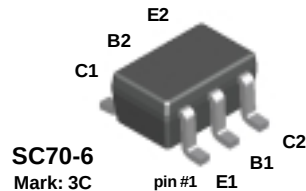


BC857S



NOTE: The pinouts are symmetrical; pin 1 and pin 4 are interchangeable. Units inside the carrier can be of either orientation and will not affect the functionality of the device.

PNP Multi-Chip General Purpose Amplifier

This device is designed for general purpose amplifier applications at collector currents to 200 mA. Sourced from Process 68.

Absolute Maximum Ratings*

$T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
V_{CEO}	Collector-Emitter Voltage	45	V
V_{CES}	Collector-Base Voltage	50	V
V_{CBO}	Collector-Base Voltage	50	V
V_{EBO}	Emitter-Base Voltage	5.0	V
I_C	Collector Current - Continuous	200	mA
T_J, T_{stg}	Operating and Storage Junction Temperature Range	-55 to +150	$^\circ\text{C}$

*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

- 1) These ratings are based on a maximum junction temperature of 150 degrees C.
- 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.
- 3) All voltages (V) and currents (A) are negative polarity for PNP transistors.

Thermal Characteristics

$T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Characteristic	Max	Units
		BC857S	
P_D	Total Device Dissipation Derate above 25°C	300 2.4	mW mW/ $^\circ\text{C}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	415	$^\circ\text{C/W}$

PNP Multi-Chip General Purpose Amplifier
(continued)

Electrical Characteristics T_A = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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OFF CHARACTERISTICS

V _{(BR)CEO}	Collector-Emitter Breakdown Voltage	I _C = 10 mA, I _B = 0	45			V
V _{(BR)CES}	Collector-Base Breakdown Voltage	I _C = 10 μA, I _E = 0	50			V
V _{(BR)CBO}	Collector-Base Breakdown Voltage	I _C = 10 μA, I _E = 0	50			V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	I _E = 10 μA, I _C = 0	5.0			V
I _{CBO}	Collector-Cutoff Current	V _{CB} = 30 V V _{CB} = 30 V, T _A = 150°C			15 4.0	nA μA

ON CHARACTERISTICS

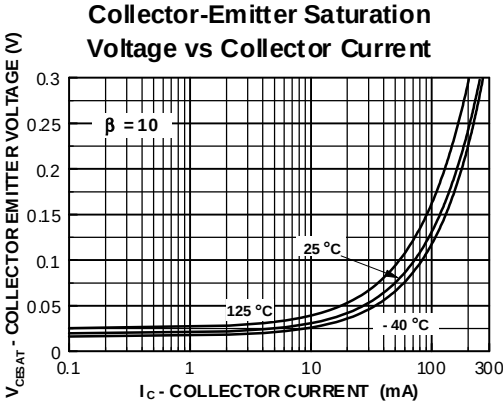
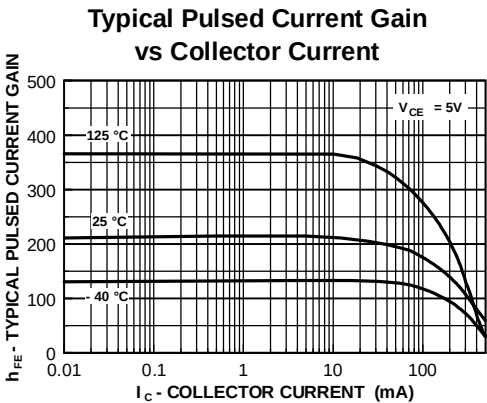
h _{FE}	DC Current Gain	I _C = 2.0 mA, V _{CE} = 5.0 V	125		630	
V _{CE(sat)}	Collector-Emitter Saturation Voltage	I _C = 10 mA, I _B = 0.5 mA I _C = 100 mA, I _B = 5.0 mA			0.3 0.65	V V
V _{BE(on)}	Base-Emitter On Voltage	I _C = 2.0 mA, V _{CE} = 5.0 V I _C = 10 mA, V _{CE} = 5.0 V	0.6		0.75 0.82	V V

SMALL SIGNAL CHARACTERISTICS

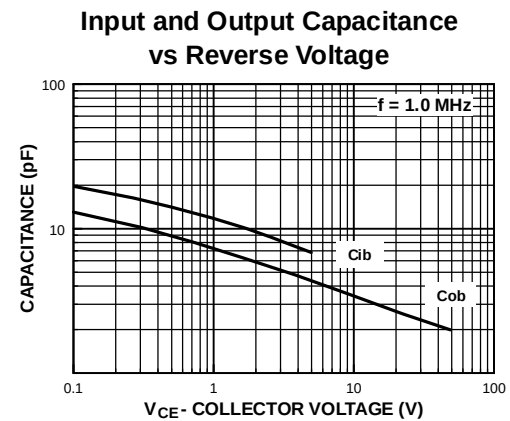
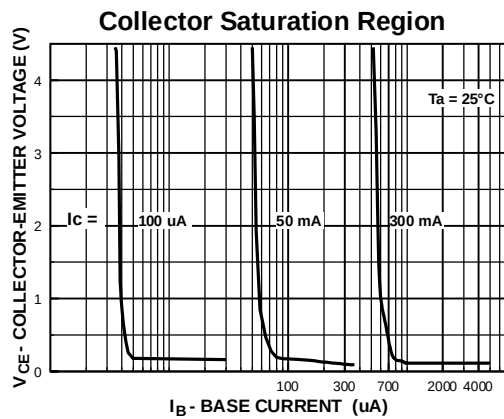
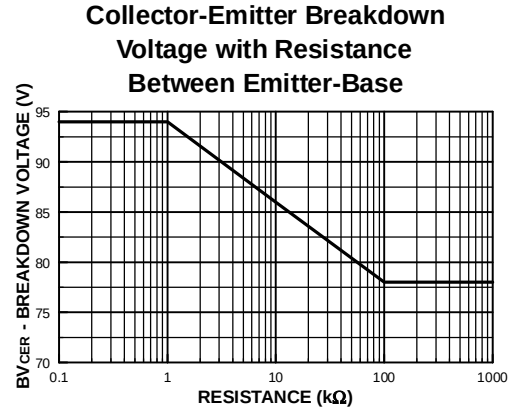
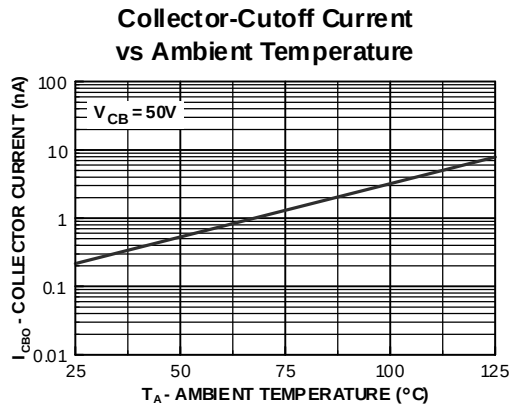
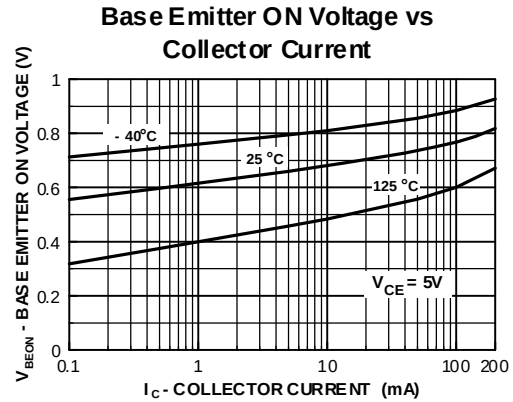
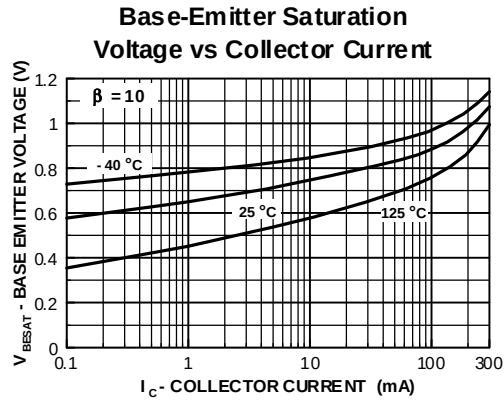
f _T	Current Gain - Bandwidth Product	I _C = 10 mA, V _{CE} = 5.0, f = 100 mHz		200		MHz
C _{obo}	Output Capacitance	V _{CB} = 10 V, f = 1.0 MHz		3.5		pF
NF	Noise Figure	I _C = 0.2 mA, V _{CE} = 5.0, R _S = 2.0 kΩ, f = 1.0 kHz, BW = 200 Hz		2.5		dB

NOTE: All voltages (V) and currents (A) are negative polarity for PNP transistors.

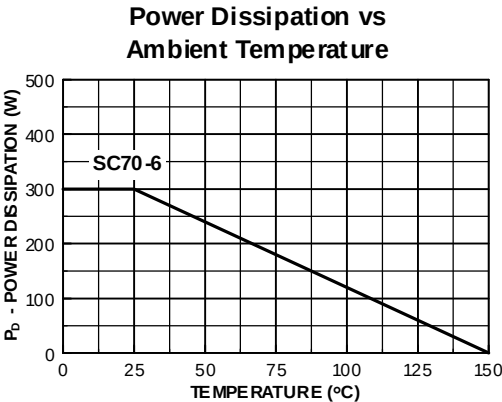
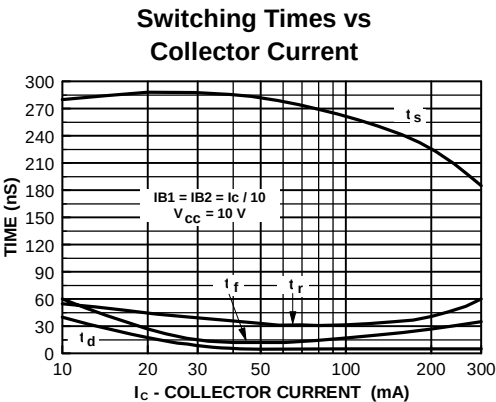
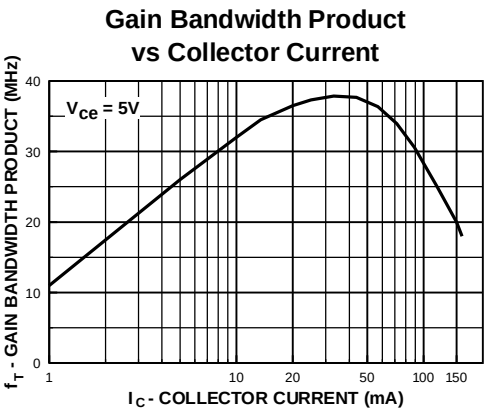
Typical Characteristics



Typical Characteristics (continued)



Typical Characteristics (continued)



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